

Description

The AO4822A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a

Battery protection or in other Switching application.



General Features SOP-8

V_{DS} = 30V I_D = 8.5A

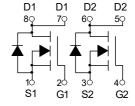
 $R_{DS(ON)} < 19m\Omega$ @ $V_{GS}=4.5V$

Application

Battery protection

Load switch

Uninterruptible power supply



Dual N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
AO4822A	SOP-8	HXY MOSFET	3000

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units	
V _{DS}	Drain-Source Voltage	30	V	
V _G S	Gate-Source Voltage	<u>+</u> 20	V	
I _D @T _A =25°C	Drain Current, V _{GS} @ 4.5V ³	8.5	Α	
I _D @T _A =70°C	Drain Current, V _{GS} @ 4.5V ³	5.8	А	
Ірм	Pulsed Drain Current ¹	37	А	
P _D @T _A =25°C	Total Power Dissipation	1.5	W	
Тѕтс	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Rthj-a	Maximum Thermal Resistance, Junction- ambient ³	85	°C/W	



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.034		V/°C
В	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =7A	17		19	m0
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =4A		22	28	mΩ
V _{GS(th)}	Gate Threshold Voltage	V -V 1 -250A	1.2		2.5	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=250uA$		-5.8		mV/°C
,	Dunin Course Lookers Course	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =7A		6		S
R_g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5		Ω
Qg	Total Gate Charge (4.5V)			6		
Q_{gs}	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =7A		2.5		nC
Q_gd	Gate-Drain Charge			2.1		
T _{d(on)}	Turn-On Delay Time			2.4		
T _r	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω		7.8		
T _{d(off)}	Turn-Off Delay Time	I _D =7A		22		ns
T _f	Fall Time			4		
C _{iss}	Input Capacitance			572		
C _{oss}	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		80		pF
C _{rss}	Reverse Transfer Capacitance			65		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,5}	\/ =\/ =0\/ Force Current			7.3	Α
I _{SM}	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			37	Α
V_{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	V
t _{rr}	Reverse Recovery Time			20		nS
Q _{rr}	Reverse Recovery Charge	lF=7A,dl/dt=100A/µs,T _J =25°C		1.1		nC

Note

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\,\leq\,300\text{us}$, duty cycle $\,\leq\,2\%$
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =21A
- 4. The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

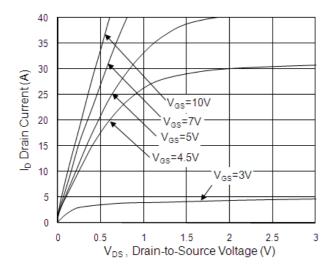


Fig.1 Typical Output Characteristics

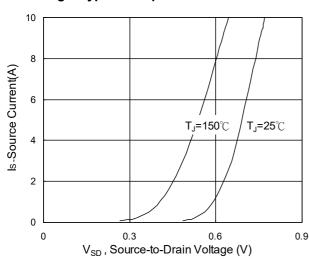


Fig.3 Forward Characteristics Of Reverse

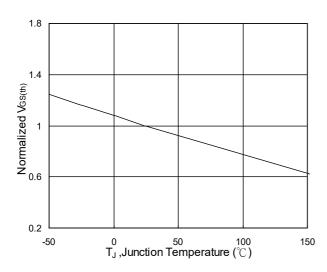


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

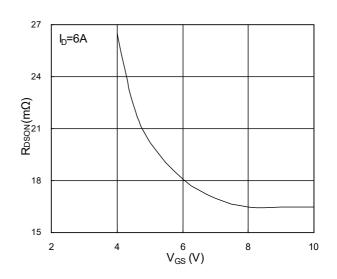


Fig.2 On-Resistance vs. G-S Voltage

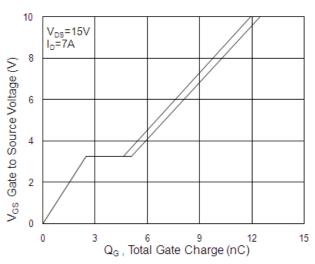


Fig.4 Gate-Charge Characteristics

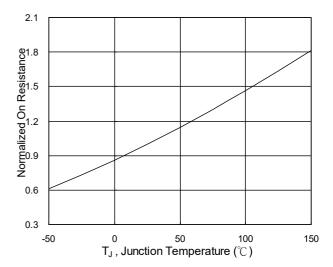
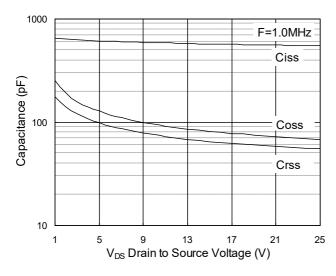


Fig.6 Normalized R_{DSON} vs. T_J





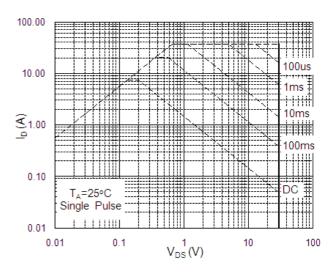


Fig.7 Capacitance

Fig.8 Safe Operating Area

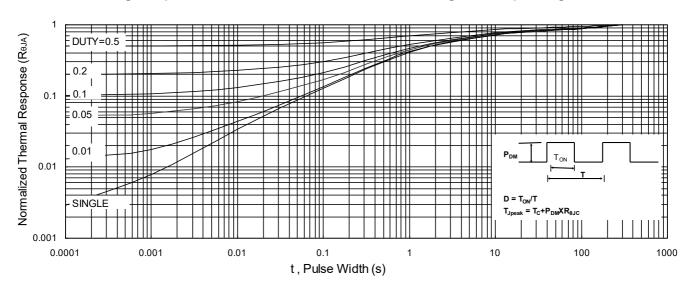


Fig.9 Normalized Maximum Transient Thermal Impedance

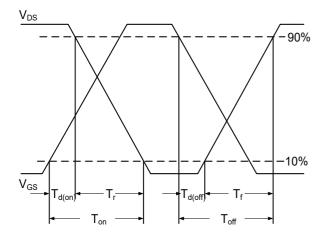


Fig.10 Switching Time Waveform

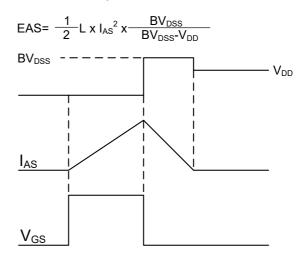
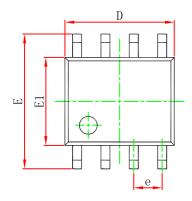
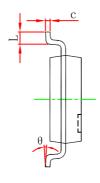


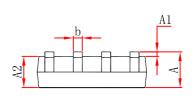
Fig.11 Unclamped Inductive Switching Waveform



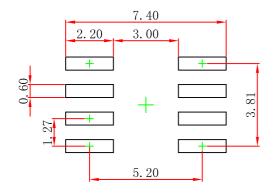
SOP-8 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
3y111001	Min	Max	Min	Max	
A	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
c	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
e	1. 270 (BSC)		0.050 (BSC)		
E	5.800	6. 200	0. 228	0.244	
E1	3.800	4.000	0.150	0.157	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



- Note: 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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